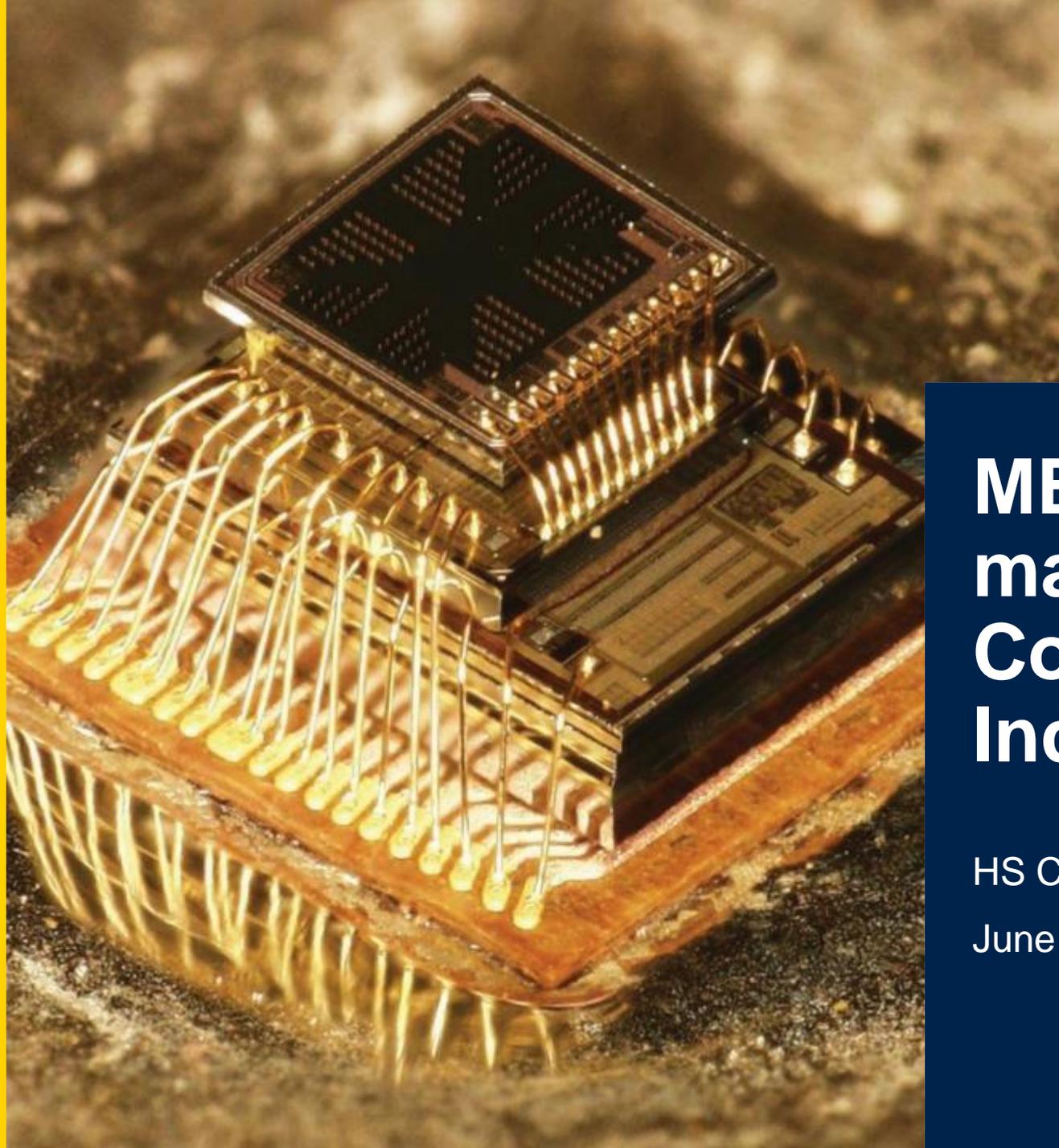




life.augmented



# **MEMS sensors in motor machinery applications Condition monitoring for Industry 4.0**

HS Chen

June 2023



~600

People



>400

Patents



>150

Product & SW libraries

## ST Milan - The home of MEMS



x2

Dual fab source



>6Mu/d

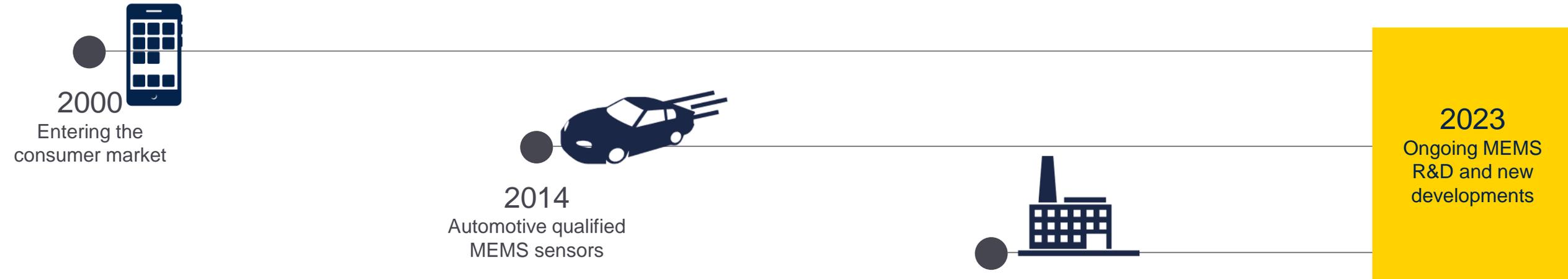
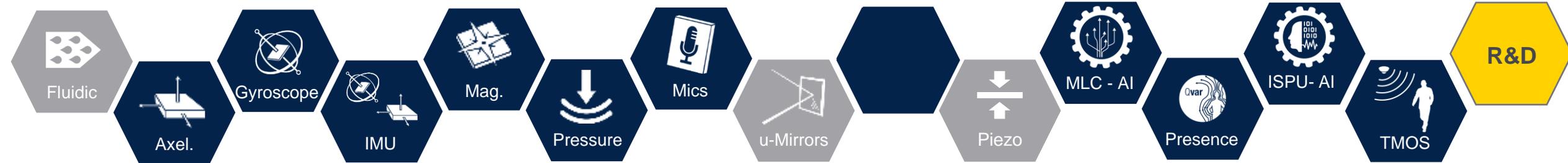
Best-in-class service



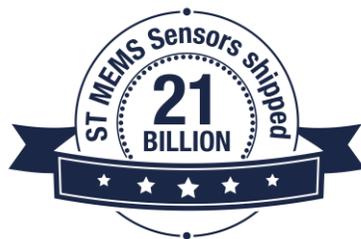
27B

Shipped sensors

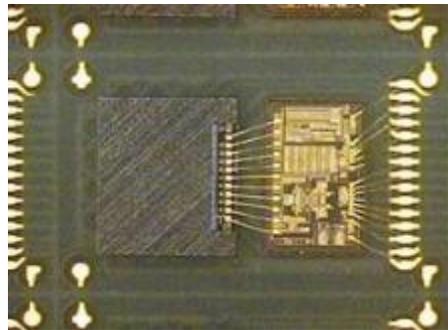
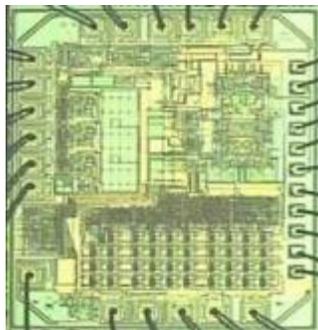
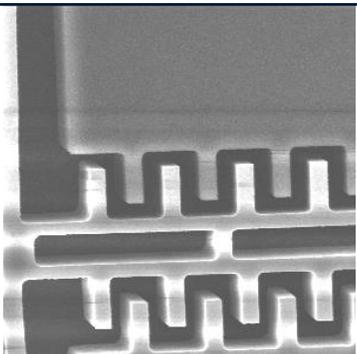
# 23 years & 27 billion MEMS at ST



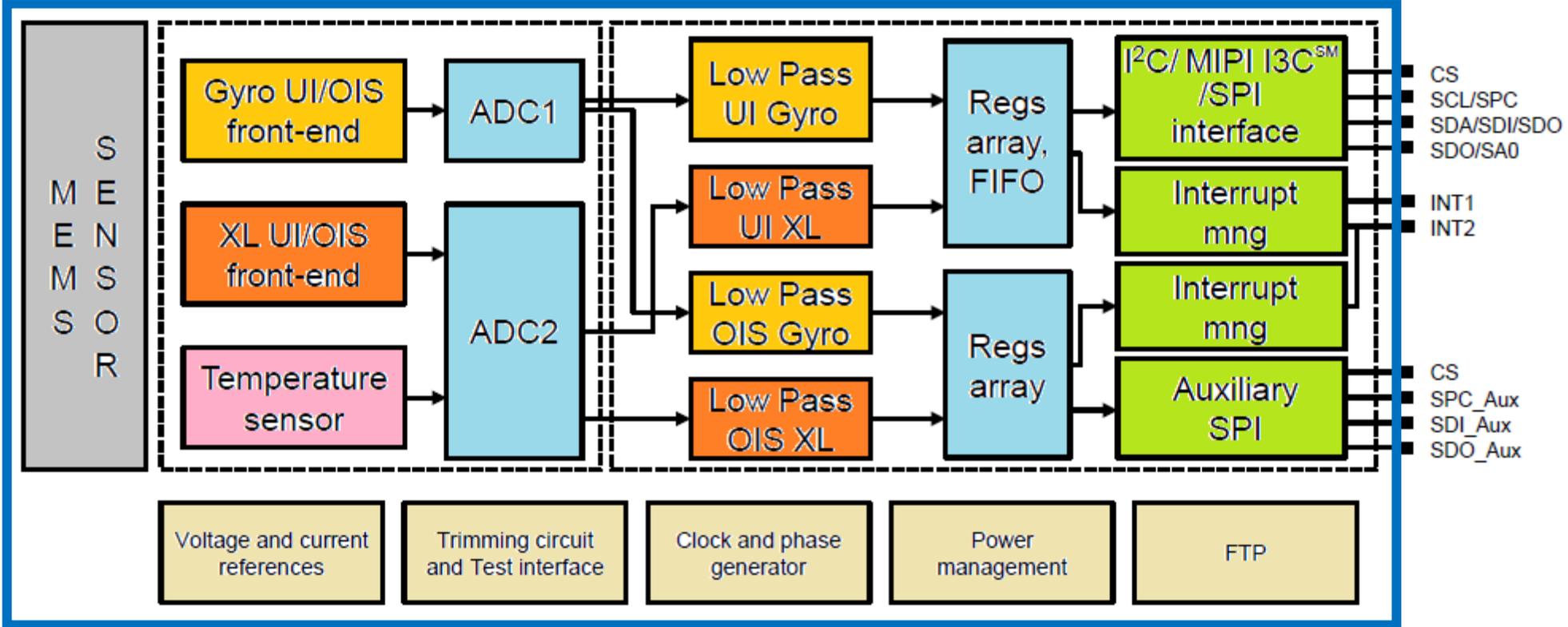
-  Sensors
-  Actuators



# Device block example



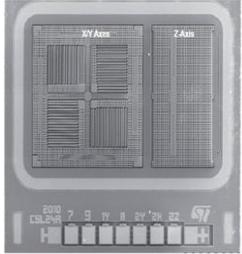
- MEMS is Micro ElectroMechanical Systems
- MEMS contain movable 3D structure
- Structure move according to external displacement



# Brief of ST MEMS sensors

# Accelerometer

## Linear acceleration measurement

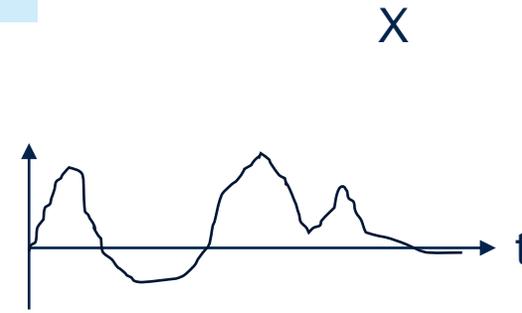
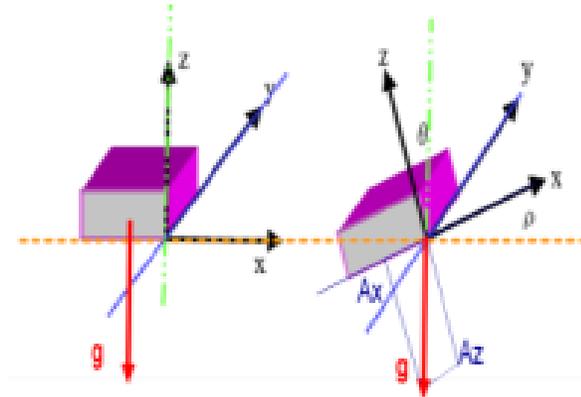
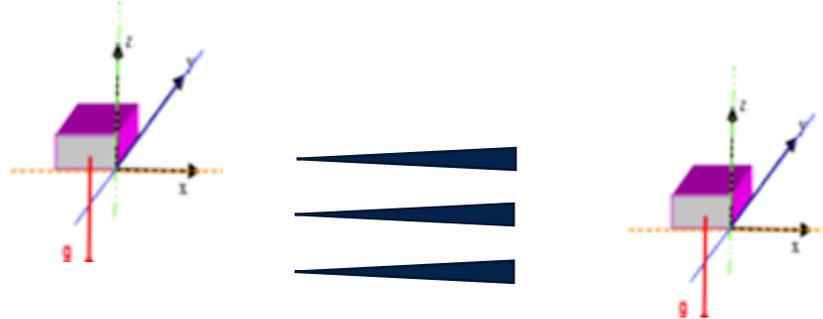


1. Accelerometer can sense linear acceleration.
2. Linear acceleration can be expressed in two forms:

$$\mathbf{A} = \frac{V_2 - V_1}{\Delta t}$$

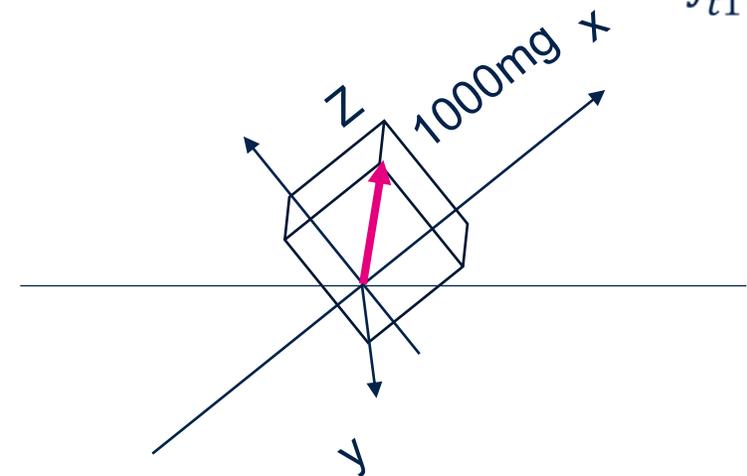
and

$$\mathbf{A} = \frac{\mathbf{F}}{m}$$



$$v(t) = \int_{t_1}^{t_2} A(t) dt$$

$$d = \int_{t_1}^{t_2} v(t) dt$$



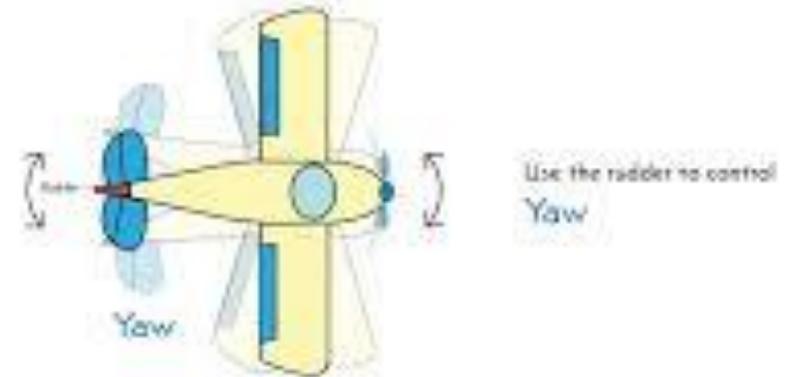
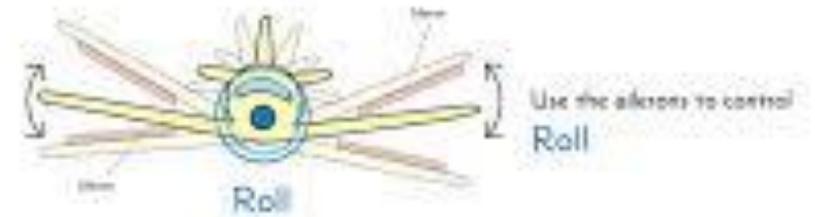
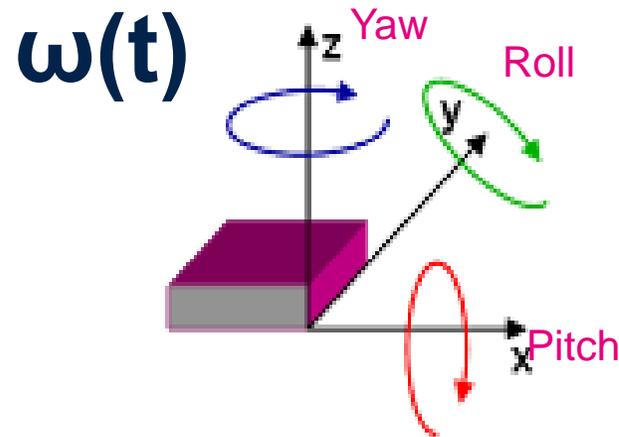
3. Output from sensor is acceleration and always expressed in mg or m/s<sup>2</sup>
4. It can be used to sense the linear acceleration (m/s<sup>2</sup>), tilt, shocks, freefall, orientation detection, vibrations, etc.

# Gyroscope

## Rotation speed measurement

1. Gyroscope can sense the rotation speed or angular rate.
2. Angular rate can be expressed in:

$$\theta = \int_{t_1}^{t_2} \omega(t) dt$$

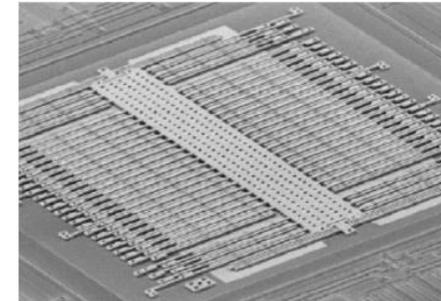
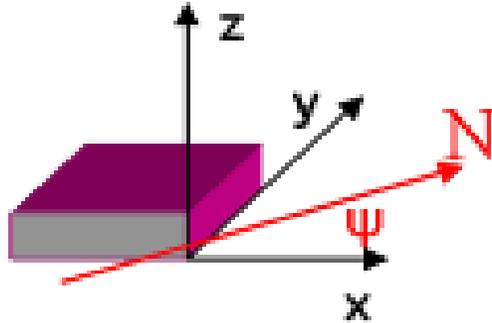
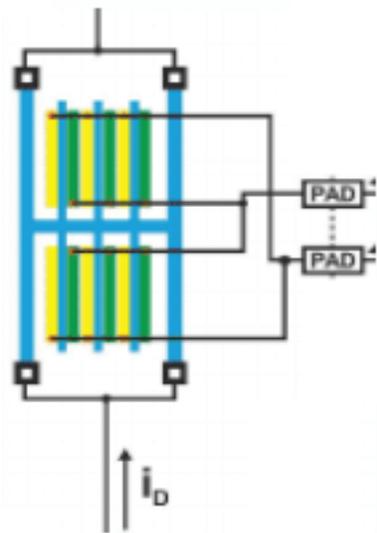


3. Output from gyroscope is in mdps ( $m^\circ /s$ ).
4. Gyroscope can be used to measure the angular rate, number of revolutions (spin), rotation of mechanical part etc.

# Magnetometer

## Magnetic field measurement

1. Magnetometer can sense **magnetic field**
2. Output of magnetic B is expressed in mGS



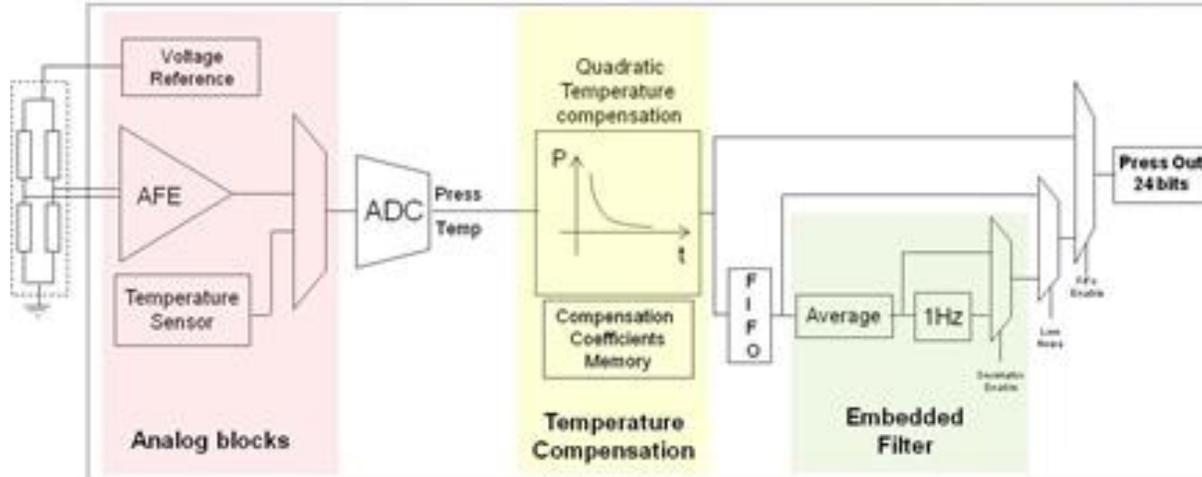
3. Magnetometer can sense the magnetic field (gauss) strength, which can be used to compute the absolute pointing direction with reference to geographical North

# Pressure sensor

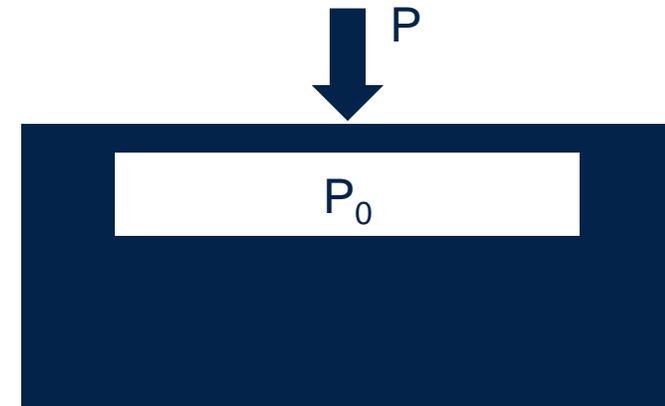
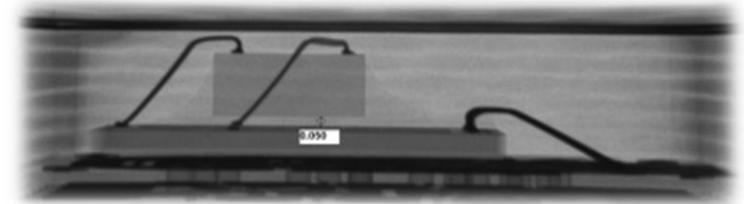
## Ambient pressure measurement

1. Pressure sensor can measure ambient pressure which can be air or liquid
2. Output of pressure sensor is expressed in mBar or hPa

• Three points temperature quadratic compensation



- Embedded FIFO = 32 samples
- Embedded filter = Average on 8/16/32 samples
- Embedded decimator to fixed to 1Hz the ODR for filtered pressure

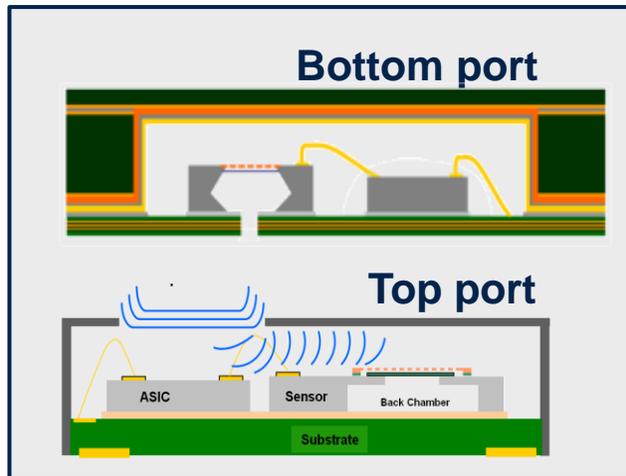


3. Pressure sensor can be used to monitor air speed, altitude, and atmospheric pressure

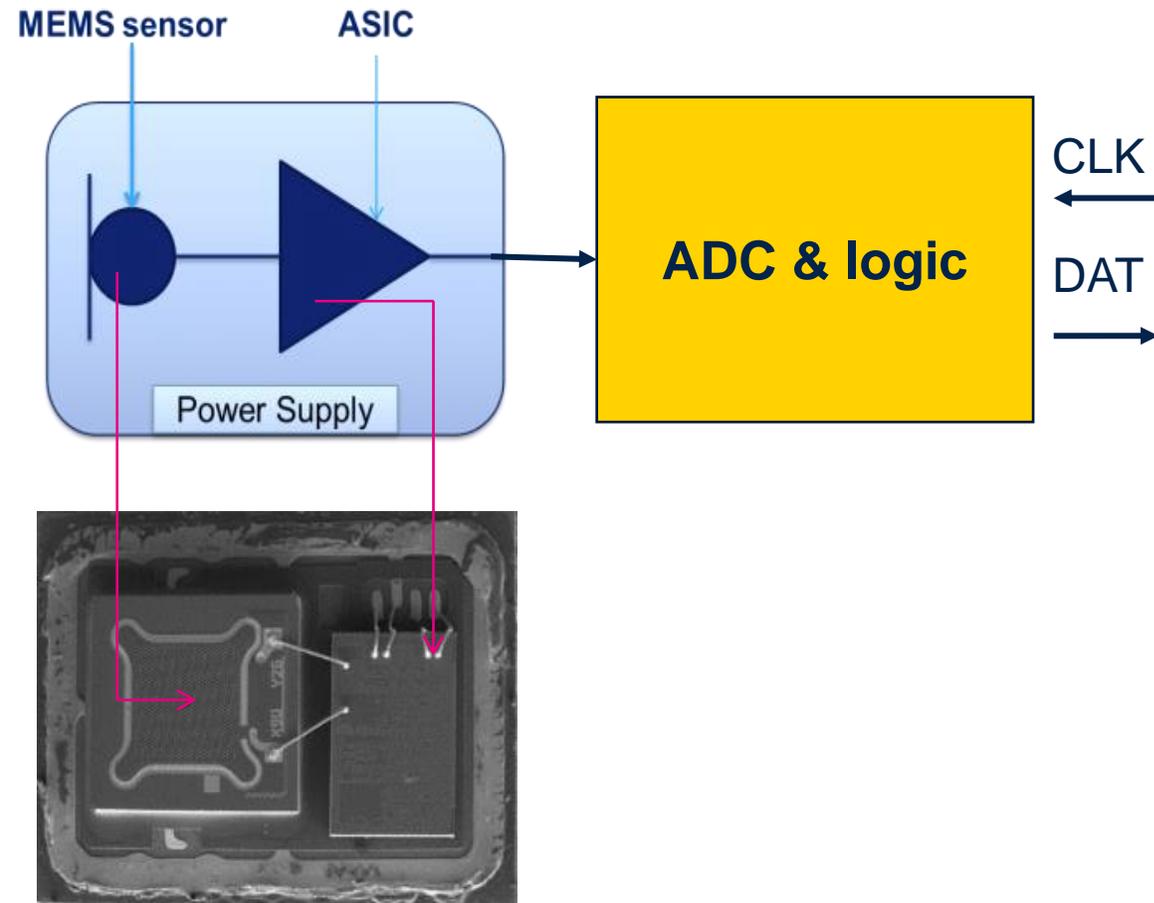
# MEMS microphone

## Acoustic measurement

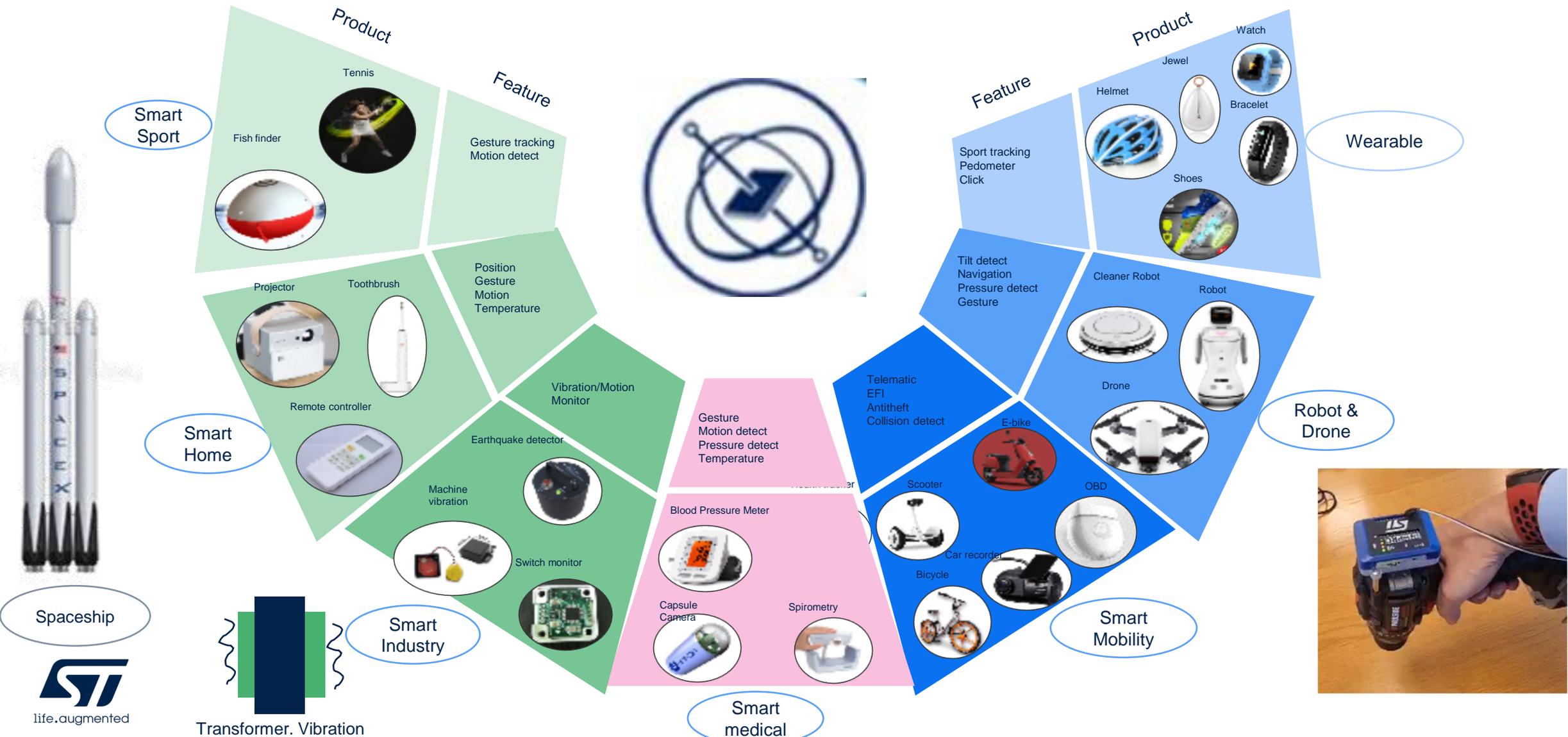
1. MEMS microphone can **pick up voice from environment**
2. Sound pressure is expressed in dB SPL in PDM for digital MIC or mV for analog MIC



- Small form factor
- Allowed reflow
- Better temperature coefficient
- Better part-part matching



# ST MEMS sensors are everywhere Applications



Spaceship



Smart Industry

Smart medical

Smart Mobility

Robot & Drone

Wearable



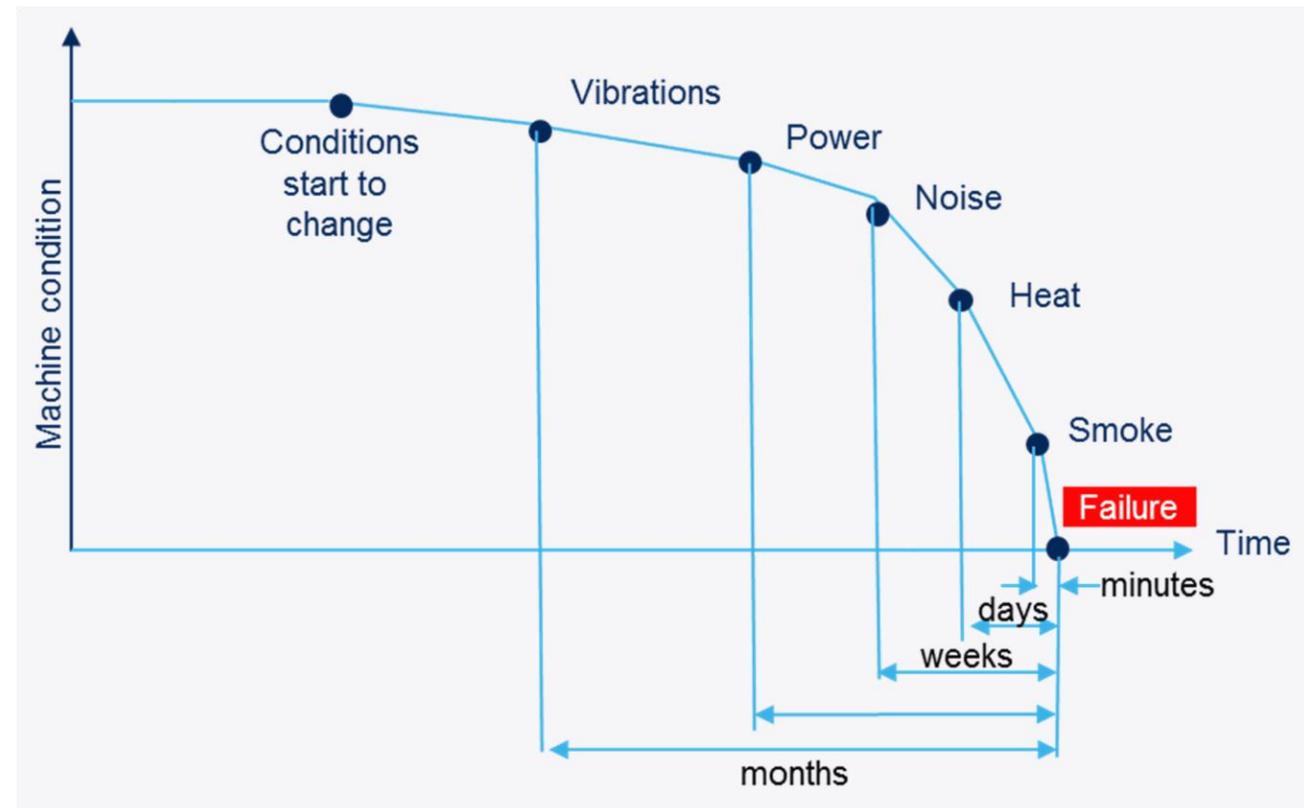
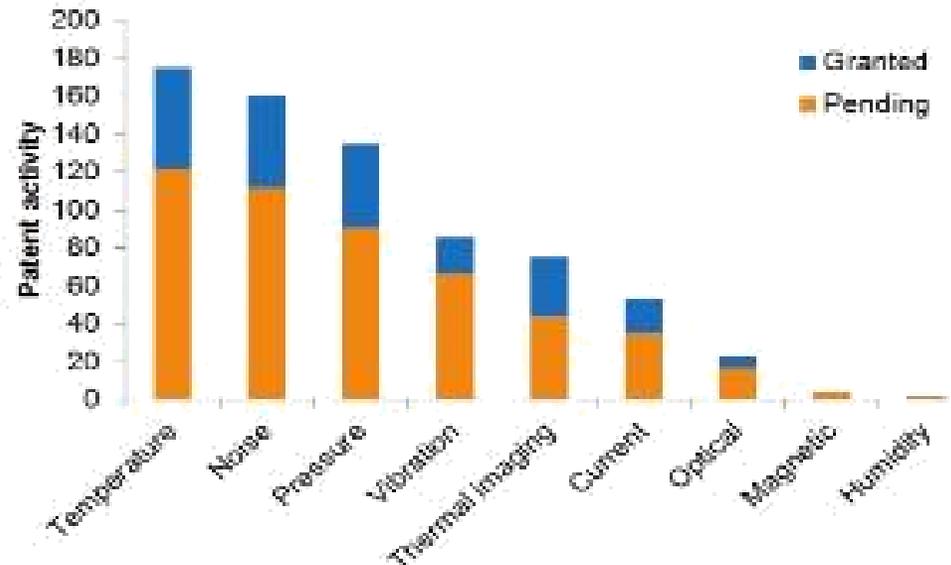
# Predictive maintenance



# Predictive maintenance starts with condition monitoring

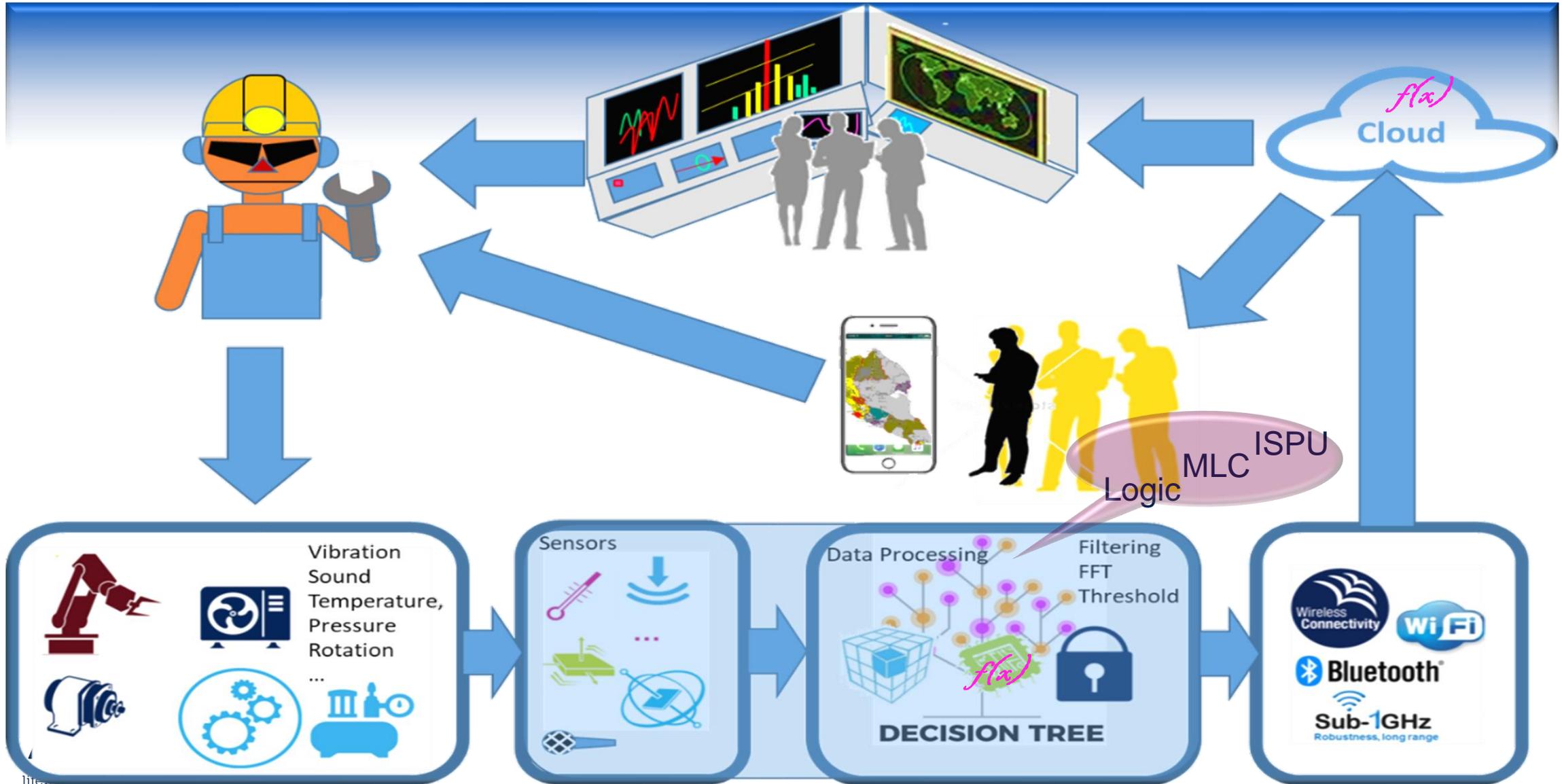
A different business model based on early sign detection, where sensors play a key role

Activities	Tradition	Predictive maintenance
Failure prevention	NA	Yes
Health condition	NA	Yes
Interactive	Human → machine	Machine → human
Diagnostic tool	Human	Sensor



# Topology of industrial 4.0

## The ecosystem



# Predictive maintenance contributing to profits



**12%** Savings of scheduled repair costs

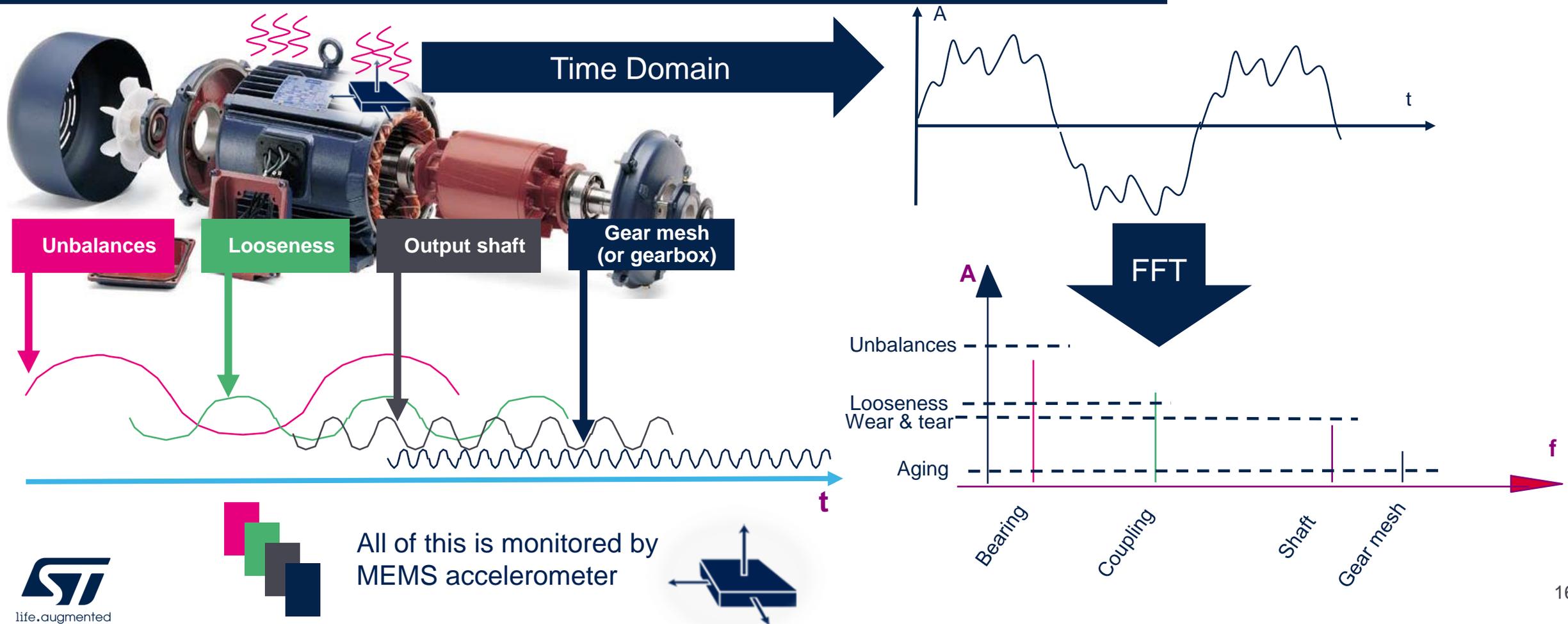
Reduction of cost due to maintenance **30%**

**50%** Reduction of machine downtime

Fewer breakdowns **70%**

# Vibration monitoring use-case with accelerometer

When we consider mechanical vibrations, a typical architecture becomes...

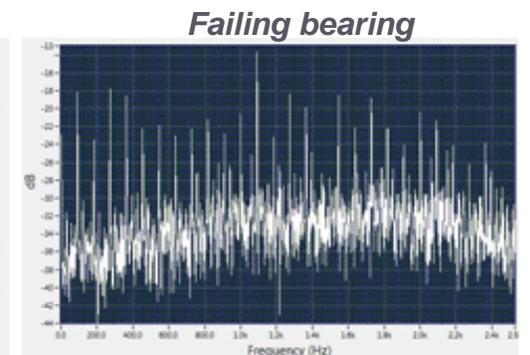
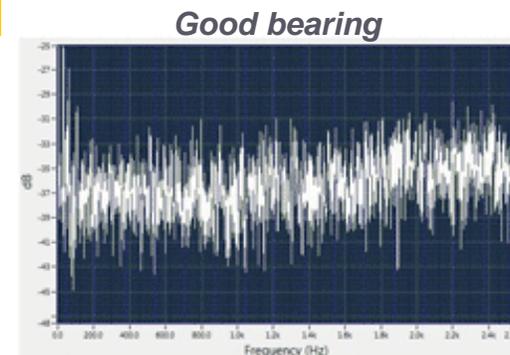
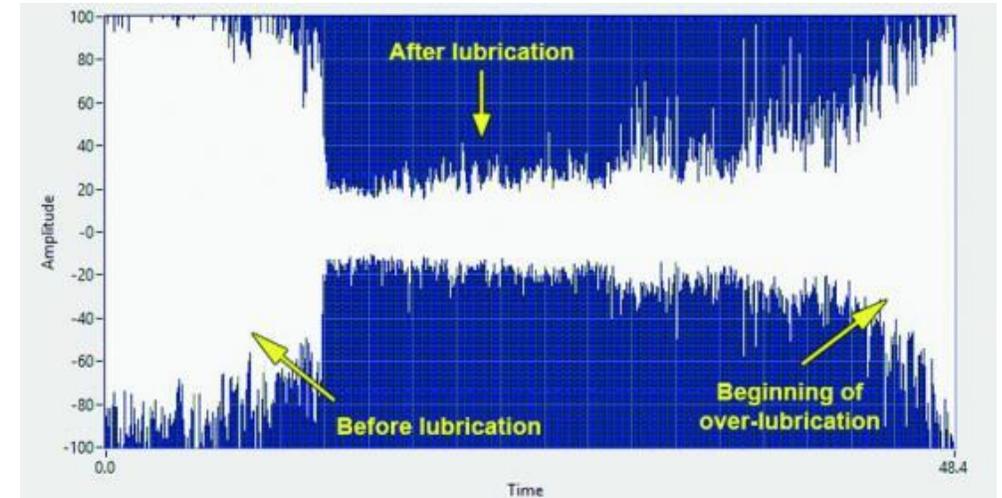


# Predictive monitoring using audio

Most common maintenance applications that can be applied at your plant today:

- Air leak detection of compressed air equipment
- Vibration monitor: all rotating equipment produces frictional forces with high-frequency ultrasonic signatures that are often masked by ambient plant noise and low frequency vibrations
- Compressor valve inspections
- Acoustic lubrication
- Heat exchanger and condenser leaks
- Hydraulic systems
- Pump cavitation

**Amplitude and frequencies matter**



# Audio frequency indicators

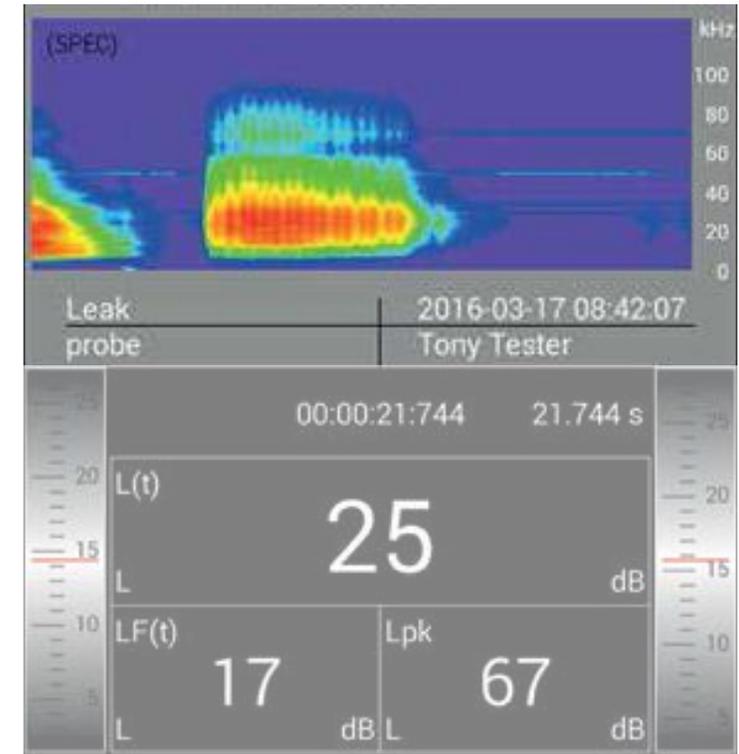
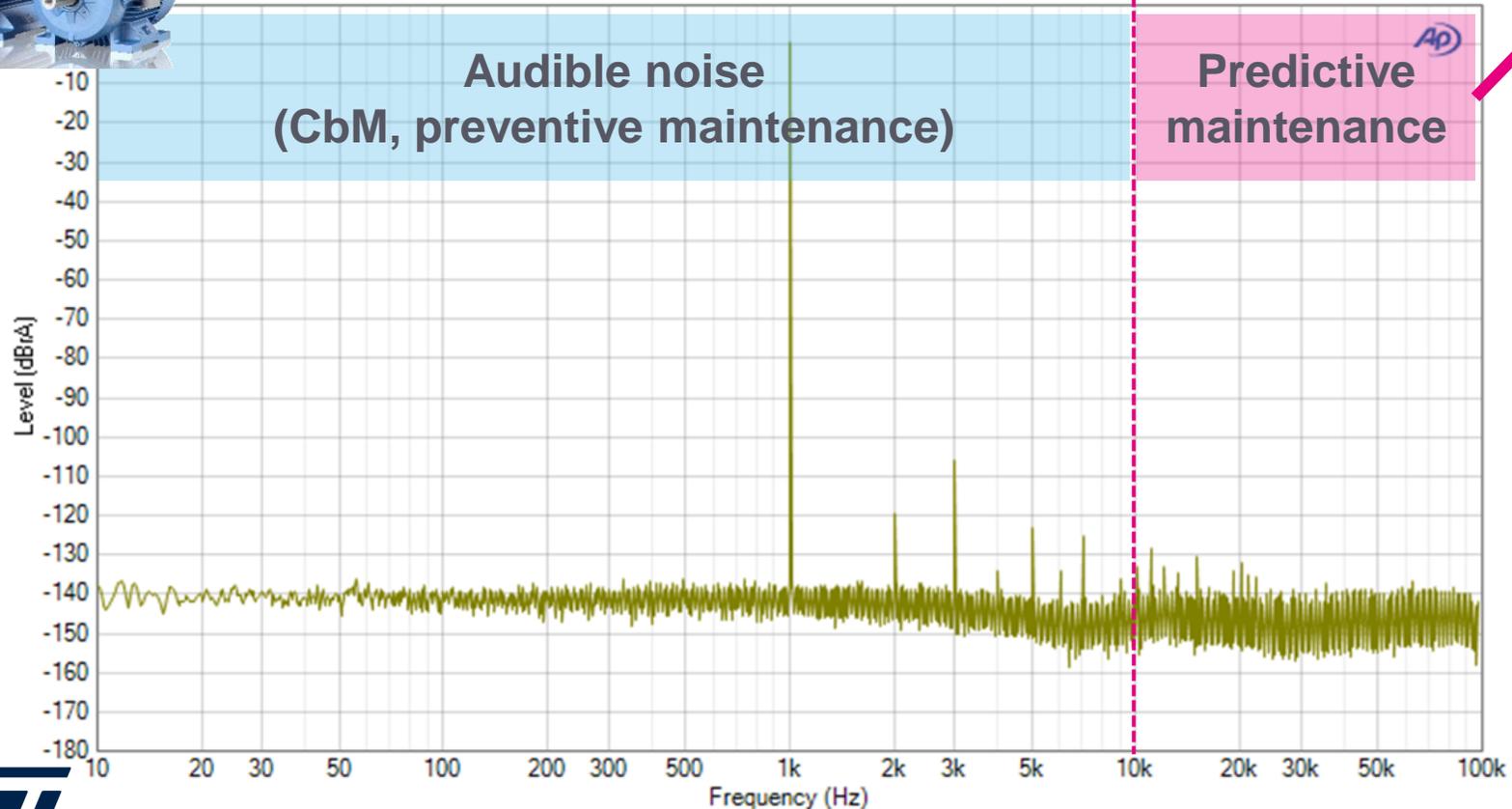
## Ultrasound – earlier diagnostic



Standard audio bandwidth

Ultrasonic

Post processing analysis  
ultrasonic frequencies to detect and  
classify leaks

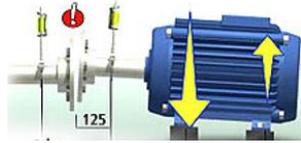


# Recommended parts



# Design your industrial IoT solution

## Use cases



Unbalance  
Looseness  
Misalignment



Roller bearings  
Gearing  
Cavitation



Bearings  
Gear Box  
Lubrication

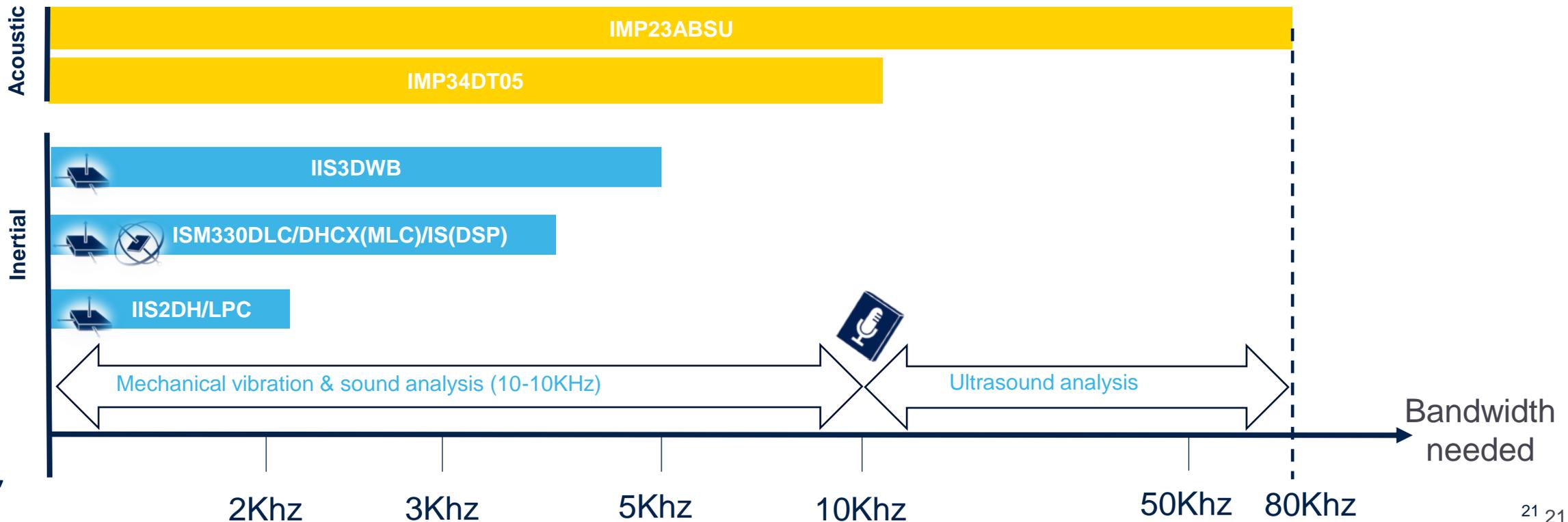


Fan bearings  
Venting occlusion  
Cooling failure



Type of defect/wear

## Sensing technologies





# ST sensors longevity program

6-axis IMU

**I3G4250D**



4 x 4 x 1 mm

- 3-axis digital gyroscope
- High linearity and stability over temperature and time

**ISM330DLC**



2.5 x 3 x 0.86 mm

- Dual Channel output
- Low power
- Smart features
- Axel with wide BW (3kHz) and low noise

- Cur Cons HP: **0.75 mA** combo
- FS: **gyro up to 2000 dps; axel up to 16 g**



**ISM330DHCX**



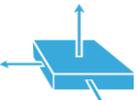
2.5 x 3 x 0.86 mm

- Enhanced machine learning core and FSM
- High accuracy and stability: (BI: 3°/hr)
- Axel with wide BW (3kHz) and low noise

- Cur Cons HP: **0.90 mA** gyro; **1.2 mA** combo
  - FS: **gyro up to 4000 dps; axel up to 16 g**
  - Extended top: **-40°C +105°C**
- MP: Q2 2019**

Axel

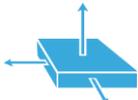
**IIS2DH**



2 x 2 x 1 mm

- Low power
- Wide BW (2 kHz)

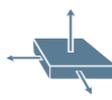
**IIS2DLPC**



2 x 2 x 0.7 mm

- Ultralow power
- High versatility: on the fly changes from ultralow power to high resolution/high performance modes

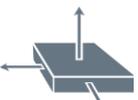
**IIS3DWB**



2.5 x 3 x 0.86 mm

- **3-axis digital axel**
  - **Ultra wide and Flat bandwidth (>5Khz)**
  - Low noise (90 µg/√Hz)
  - Low power (1.1mA)
  - Extended top: **-40°C +105°C**
  - **Ideal for vibration monitoring**
- MP: Q3 2019**

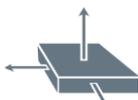
**IIS328DQ**



4 x 4 x 1.8 mm

- Extended top: **-40°C +105°C**
- QFN package

**IIS3DHHC**



5 x 5 x 1.7 mm

- **3 axis digital inclinometer**
- High resolution and stability over temperature and time
- High end ceramic package

**IIS2ICLX**



5 x 5 x 1.7 mm

- 
- **2 axis digital inclinometer**
  - **Enhanced machine learning core and FSM**
  - Ultra High resolution and stability over temperature and time
  - Low power
  - Extended top: **-40°C +105°C**
- MP: Q3 2019**

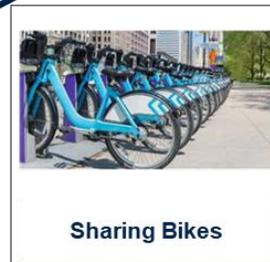
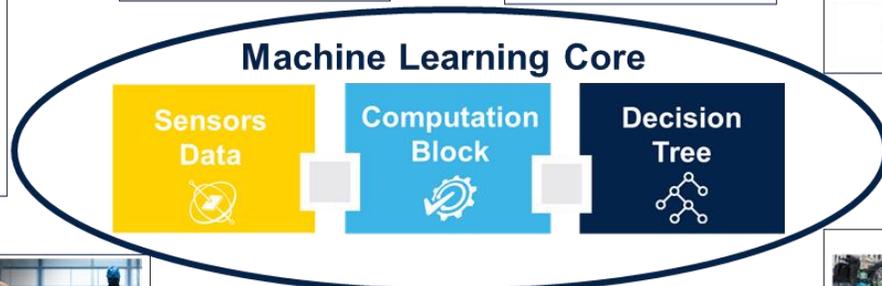
- Cur Cons: **0.42 mA**
- FS: **± 0.5/1.0/2.0/4.0**



# Real edge computing with Machine Learning core

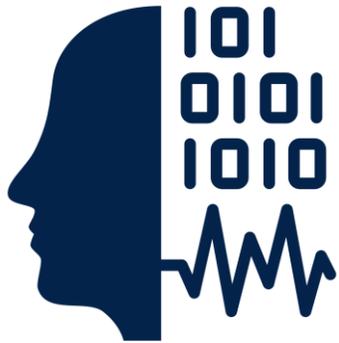
## Simple, intuitive, and extremely low power

- Mean
- Variance
- Energy
- Peak-to-Peak
- 0 crossing
- Peak detector
- Min & Max



<p>LSM6DSOX</p> <p>SUSTAINABLE TECHNOLOGY</p>	Activity recognition	LSM6DSOX
	Gym activity recognition	MLC: 256 nodes
	Airplane mode detection	FS: $\pm 2000$ dps, $\pm 16$ g G_OffDr: $\pm 0.010$ dps/ $^{\circ}$ C Cus cons: 0.55 mA combo T <sub>Op</sub> : -40 $^{\circ}$ C +105 $^{\circ}$ C
<p>LSM6DSRX</p> <p>SUSTAINABLE TECHNOLOGY</p>	Virtual Reality	LSM6DSRX
	Sensor Fusion	MLC: 512 nodes
	Vehicle stationary detection	FS: $\pm 4000$ dps, $\pm 16$ g G_OffDr: $\pm 0.005$ dps/ $^{\circ}$ C Cus cons: 1.2 mA combo T <sub>Op</sub> : -40 $^{\circ}$ C +85 $^{\circ}$ C
<p>ISM330DHCX</p> <p>SUSTAINABLE TECHNOLOGY</p> <p>LONGEVITY 10 YEARS COMMITMENT</p>	Smart antennas	ISM330DHCX
	Industrial IoT	Industrial
	Dynamic inclinometers	MLC: 512 nodes FS: $\pm 4000$ dps, $\pm 16$ g G_OffDr: $\pm 0.005$ dps/ $^{\circ}$ C Cus cons: 1.2 mA combo T <sub>Op</sub> : -40 $^{\circ}$ C +105 $^{\circ}$ C
<p>IIS2ICLX</p> <p>SUSTAINABLE TECHNOLOGY</p> <p>LONGEVITY 10 YEARS COMMITMENT</p>	Structural health monitoring	IIS2ICLX
	Leveling instruments	MLC: 512 nodes
	Equipment installation and monitoring	FS: $\pm 3$ g Ultra low noise: 15 $\mu$ g/ $\sqrt{\text{Hz}}$ X_OffDr: $< 0.075$ mg/ $^{\circ}$ C T <sub>Op</sub> : -40 $^{\circ}$ C +105 $^{\circ}$ C

# ISPU added value



## Ultra low power consumption

- Efficiency of the embedded DSP (digital signal processing)
- Very low data exchange with external MCU (MCU stay in sleep mode most of the time)



## Ultra low latency

- Processing / decision taken directly in the sensor



## Easily programmable with C language or with commercial or open-source AI models



NANOEDGE AI



## Data privacy & security

- Sensor data are locally processed and not provided outside



## Integration / miniaturization

- MEMS mixed-signal state-of-the-art technology node
- No special purpose package

# Intelligent sensor processing unit (ISPU)

Smartphone / Wearable / OIS

Virtual / Augmented Reality / Drone

Smartphone / Wearable / OIS

True Wireless System

MLC  
+  
FSM

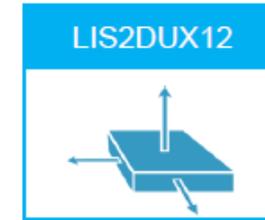
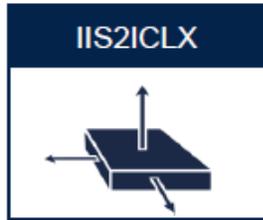


Industrial monitoring

Structural monitoring/inclinometer

Telematic box/Car Alarm

Asset tracking/Alarm



MLC+FSM 1.0

MLC+FSM 2.0

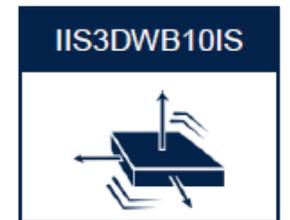
- ISPU answers the demand of edge computing!
- Local decision making
- Reduce system power consumption
- Offload tasks from host



Smartphone / Wearable / OIS

Industrial monitoring

Industrial vibration



Consumer

Industrial

Automotive

2020/2021

2022/2024

# Our technology starts with You



Find out more at [www.st.com](http://www.st.com)

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